### Mechatronics Systems Design Laboratory ECE 491

Igor Paprotny

#### **Upcoming Checkout**

- This week: soldering lab (lab 1)
- Next week: FRDM-KL25Z lab 2 (GPIO and ADC)

- Safety write-up on BB
- Project proposal due next Friday (project proposal guidelines on BB soon)



#### **Igor Paprotny**

Interests: EE, Robotics, MEMS

What I want to get out of ECE 491: Have an awesome time teaching it!

webpage: http://www1.ece.uic.edu/~paprotny/

### **Soldering Basics**

- Clean area
- Pre-tin wires and tip
- Clamp your work
- Apply heat to the wire and the pad
- Add solder to the part not the iron
- Apply for ~ 5 sec.
  - Should wet part and pad clearly
- Clear the flux residue



Good!



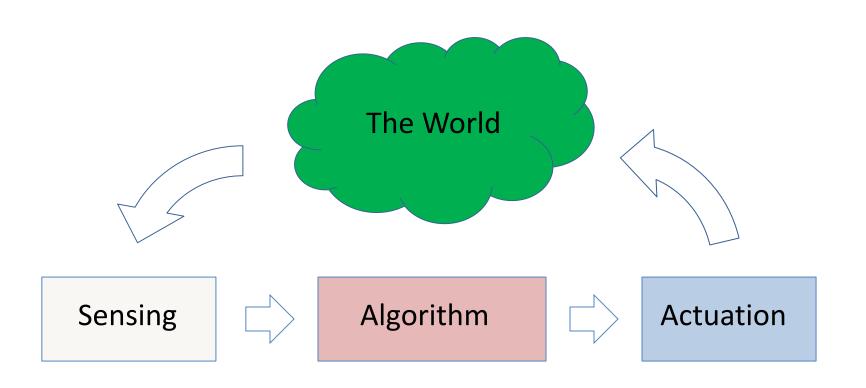
BAD!

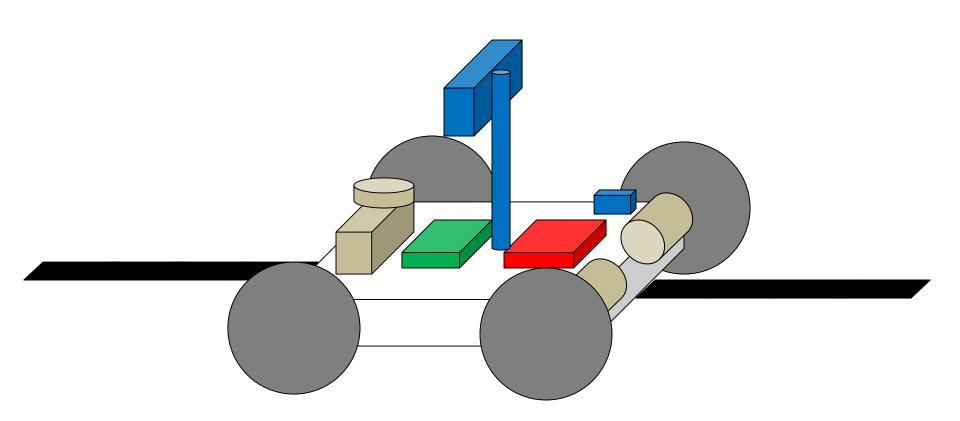
Review this:

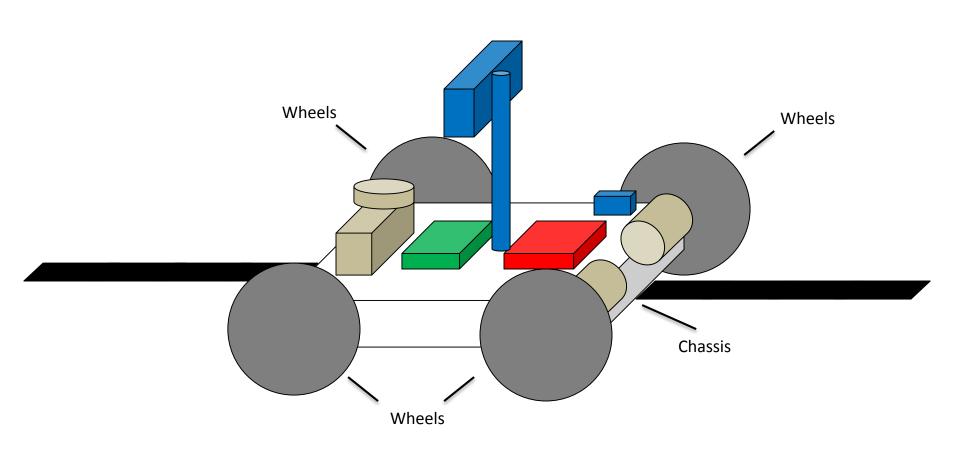


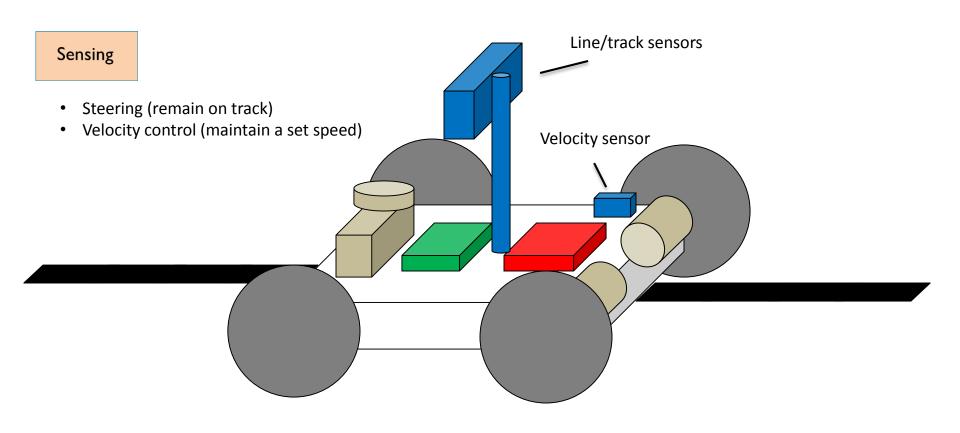
http://store.curiousinventor.com/guides/how\_to\_solder/

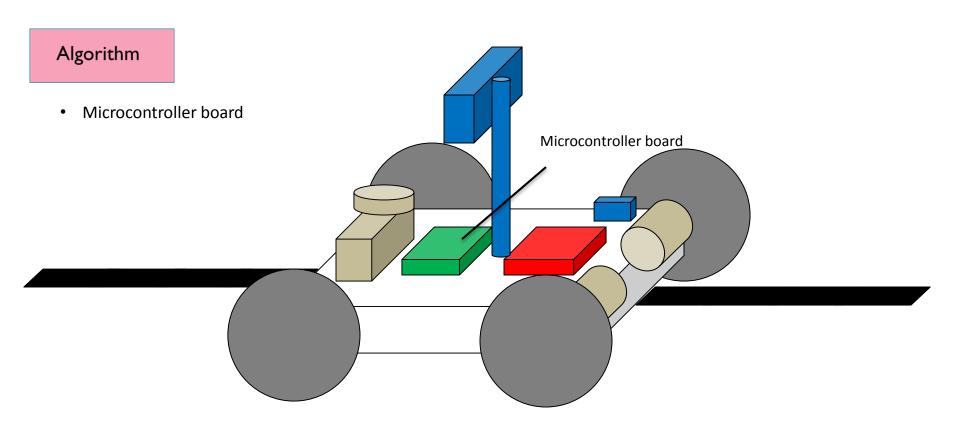
## Introduction of Mechatronic Systems Design

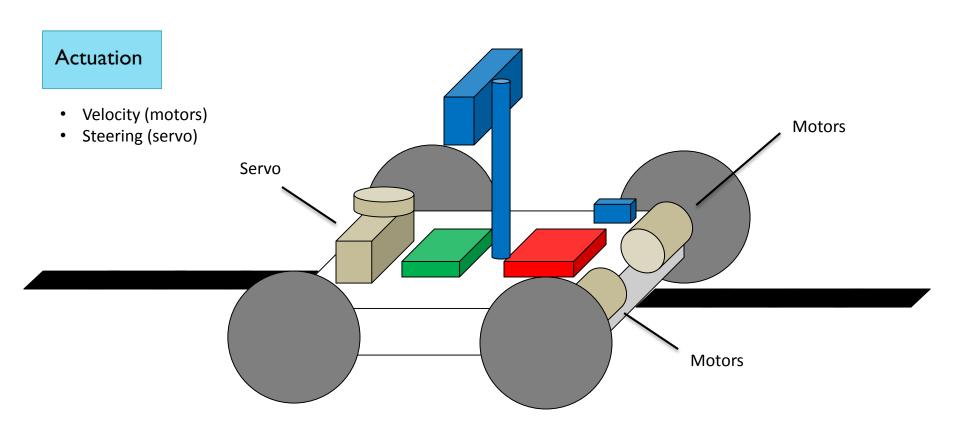


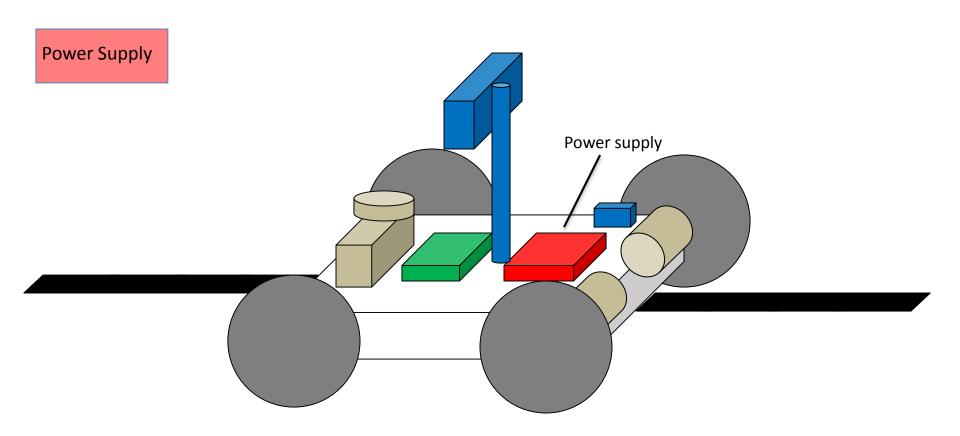








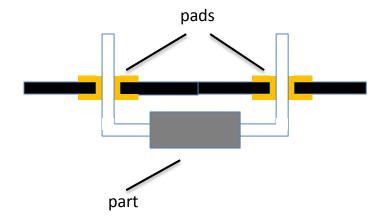




### Review of Preliminaries - Soldering

#### Steps necessary for good soldering:

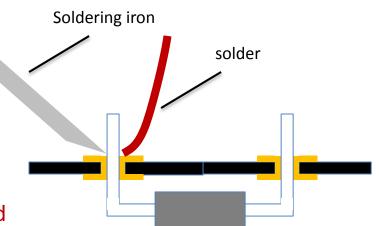
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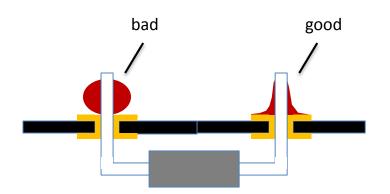
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#### FRDM-KL25Z Manual

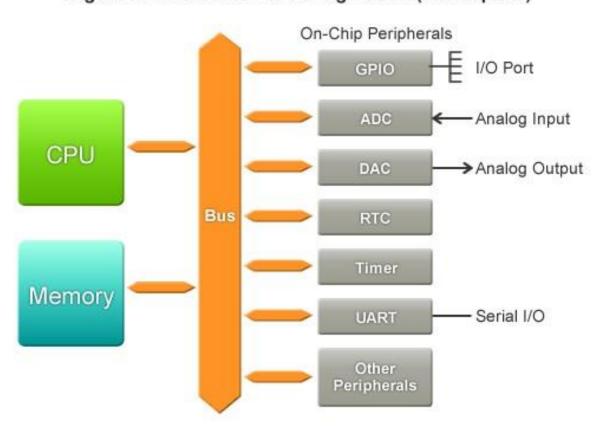


### MCU – I/O structure

**GPIOs** and ADCs

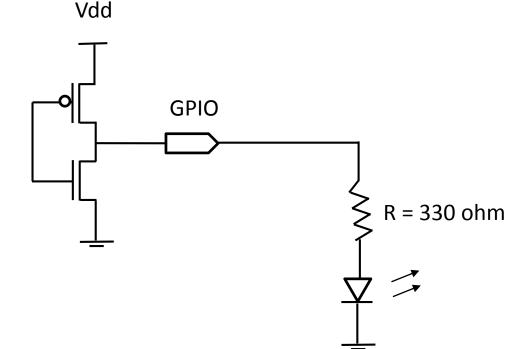
### MCU I/Os

Figure 1: MCU's Internal Configuration (Conceptual)



## General Purpose I/O's (GPIO)

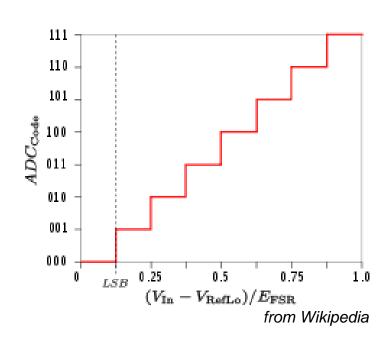
- General Purpose Input Outputs (GPIO)
  - reconfigurable Input/Output
  - digital (1 (high) or 0 (low))
  - need to be configured in software (lab 2)



### Analog to Digital Converters (ADCs)

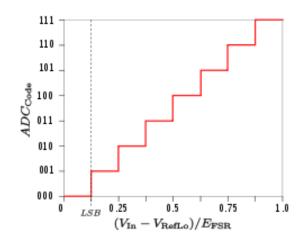
- Analog to Digital Converter
  - Can read in the analog value
  - Input pins need to be configured
- FDM board uses:
  - 16-bit Successive Approximation (SARC) ADC
  - 12-bit DAC

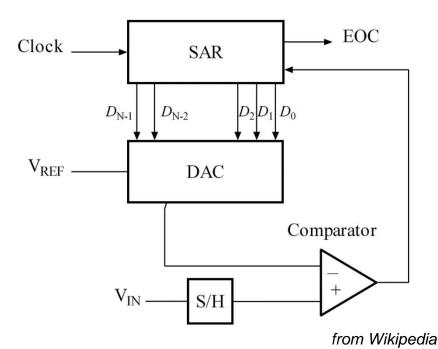
**Use processor Expert** 



#### **ADCs**

- Successive Approximation ADC
  - Allow the Microcontroller to sample an analog waveform
  - Common type of ADCs
  - S/N: Sample and hold register
  - SAR: Successive Approximation Register
  - DAC: Digital to Analog Converter
  - EOC: end of conversion





#### Timers and Interrupts

#### Interrupts:

- Allow code execution on an event.
- External interrupts or software interrupts (timers)

#### Timers:

- Allows code to be triggered after some elapsed time
- Can be used to trigger PWM
- Sleep timer (low power mode)

**Set in processor Expert** 

#### Demo

**Processor Expert**